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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: TREJO, LUIS
Patent/Application No: 6,898,849
Granted/Filed: 05/31/2005
Art Unit:
Examiner:
Docket No.: TI-21129
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NAME OF INVENTOR(S) TREJO, LUIS		RECEIPT DATE & SERIAL NO.: Patent/App'n No.: 6,898,849 Grant/Filing Date: 05/31/2005
TITLE OF INVENTION: METHOD FOR CONTROLLING WIRE BALLS IN ELECTRONIC BONDING		
TITLE NO. TI-21129	DEPOSIT ACCT. NO.: 20-0668	
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265